# ANALOG<br/>DEVICES700 MHz to 3000 MHz Dual Passive<br/>Receive Mixer with Integrated PLL and VCO

### **Data Sheet**

# **ADRF6612**

#### FEATURES

RF frequency: 700 MHz to 3000 MHz, continuous LO input frequency: 200 MHz to 2700 MHz, high-side or lowside injection IF range: 40 MHz to 500 MHz Power conversion gain of 9.0 dB Single sideband (SSB) noise figure of 11.3 dB Input IP3 of 30 dBm Input P1dB of 10.6 dBm Typical LO input drive of 0 dBm Single-ended, 50 Ω RF port Single-ended or balanced LO input port Serial port interface (SPI) control on all functions Exposed pad, 7 mm × 7 mm, 48-lead LFCSP

#### **APPLICATIONS**

Multiband/multistandard cellular base station diversity receivers

Wideband radio link diversity downconverters Multimode cellular extenders and picocells

#### **GENERAL DESCRIPTION**

The ADRF6612 is a dual radio frequency (RF) mixer and intermediate frequency (IF) amplifier with an integrated phaselocked loop (PLL) and voltage controlled oscillators (VCOs). The ADRF6612 uses revolutionary broadband square wave limiting local oscillator (LO) amplifiers to achieve an unprecedented RF bandwidth of 700 MHz to 3000 MHz. Unlike narrow-band sine wave LO amplifier solutions, the LO can be applied above or below the RF input over an extremely wide bandwidth. Energy storage elements are not utilized in the LO amplifier, thus dc current consumption also decreases with decreasing LO frequency.

The ADRF6612 utilizes highly linear, doubly balanced passive mixer cores with integrated RF and LO balancing circuits to allow single-ended operation. Integrated RF baluns allow optimal performance over the 700 MHz to 3000 MHz RF input frequency. The balanced passive mixer arrangement provides outstanding LO to RF and LO to IF leakages, excellent RF to IF isolation, and excellent intermodulation performance over the full RF bandwidth.

The balanced mixer cores provide extremely high input linearity, allowing the device to be used in demanding

#### FUNCTIONAL BLOCK DIAGRAM



wideband applications where in band blocking signals may otherwise result in the degradation of dynamic range. Noise performance under blocking is comparable to narrow-band passive mixer designs. High linearity IF buffer amplifiers follow the passive mixer cores, yielding typical power conversion gains of 9 dB, and can be matched to a wide range of output impedances.

The PLL architecture supports both integer-N and fractional-N operation and can generate the entire LO frequency range of 200 MHz to 2700 MHz using an external reference input frequency anywhere in the range of 12 MHz to 320 MHz. An external loop filter provides flexibility in trading off phase noise vs. acquisition time. To reduce fractional spurs in fractional-N mode, a sigma-delta ( $\Sigma$ - $\Delta$ ) modulator controls the post-VCO programmable divider. The VCO consists of multiple VCO cores.

All features of the ADRF6612 are controlled via a 3-wire SPI resulting in optimum performance and minimum external components.

The ADRF6612 is fabricated using a BiCMOS, high performance IC process. The device is available in a 7 mm  $\times$  7 mm, 48-lead LFCSP package and operates over a  $-40^{\circ}$ C to  $+85^{\circ}$ C temperature range. An evaluation board is available.

Rev. A

**Document Feedback** 

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### EVALUATION KITS

ADRF6612 Evaluation Board

### **DOCUMENTATION**

#### **Data Sheet**

 ADRF6612: 700 MHz to 3000MHz Dual Passive Receive Mixer with Integrated PLL and VCO Data Sheet

#### **User Guides**

 UG-968: Evaluating the ADRF6612/ADRF6614, 700 MHz to 3000 MHz Rx Dual Mixer with Integrated Fractional-N PLL and VCO

### REFERENCE MATERIALS

#### Press

 Analog Devices Introduces High-Performance RF ICs for Multi-band Base Stations and Microwave Point-to-Point Radios

#### **Product Selection Guide**

RF, Microwave, and Millimeter Wave IC Selection Guide 2017

### DESIGN RESOURCES

- ADRF6612 Material Declaration
- PCN-PDN Information
- Quality And Reliability
- Symbols and Footprints

### DISCUSSIONS

View all ADRF6612 EngineerZone Discussions.

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### **SPECIFICATIONS**

### **RF SPECIFICATIONS**

 $T_{A} = 25^{\circ}C, f_{RF} = 1900 \text{ MHz}, f_{LO} = 1697 \text{ MHz}, Z_{O} = 50 \Omega, \text{ frequency of the reference } (f_{REF}) = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{REF} \text{ power} = 4 \text{ dBm}, f_{PFD} = 122.88 \text{ MHz}, f_{PFD} = 122.88 \text{ MHz}$ 1.536 MHz, low-side LO injection, optimum RF balun (RFB) and low-pass filter (LPF) settings, unless otherwise noted.

Table 1. High Performance Mode					
Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
RF INTERFACE					
Return Loss	Tunable to >20 dB broadband via serial port		17.9		dB
Input Impedance			50		Ω
RF Frequency Range (f <sub>RF</sub> )		700		3000	MHz
IF OUTPUT INTERFACE					
Output Impedance	Differential impedance, f = 200 MHz		300  1.5		Ω∥pF
IF Frequency Range		40		500	MHz
DC Bias Voltage <sup>1</sup>	Externally generated		IFOUTx±		V
EXTERNAL LO INPUT					
External LO Power Input		-5	0	+5	dBm
Return Loss			-11		dB
Input Impedance			50		Ω
External VCO Input Frequency	External VCO input supports divide by 1, 2, 4, 8, 16, and 32	250		5700	MHz
LO Frequency Range	Low-side or high-side LO, internally or externally generated	250		2850	MHz
DYNAMIC PERFORMANCE					
Power Conversion Gain	4:1 IF port transformer and printed circuit board (PCB) loss removed		9.0		dB
Voltage Conversion Gain	$Z_{\text{SOURCE}} = 50 \Omega$ , differential $Z_{\text{LOAD}} = 200 \Omega$		15.0		dB
SSB Noise Figure			11.3		dB
IF Output Phase Noise Under Blocking	10 dBm blocker present 10 MHz above desired RF input, $f_{\text{RF}}$ = 1900 MHz, $f_{\text{BLOCK}}$ = 1910 MHz, $f_{\text{LO}}$ = 1697 MHz, IF = 203 MHz,		-153		dBc/Hz
	$IF_{BLOCKER} = 213 \text{ MHz}$				10
Input Third-Order Intercept (IIP3)	$f_{RF1} = 1900 \text{ MHz}, f_{RF2} = 1901 \text{ MHz}, f_{LO} = 1697 \text{ MHz}, each RF tone at -10 dBm$		30		dBm
Input Second-Order Intercept (IIP2)	$f_{\text{RF1}}=1900$ MHz, $f_{\text{RF2}}=1950$ MHz, $f_{\text{LO}}=1697$ MHz, each RF tone at $-10$ dBm		60		dBm
Input 1 dB Compression Point (P1dB)			10.6		dBm
LO to IF Output Leakage	Unfiltered IF output		-35		dBm
LO to RF Input Leakage			-45		dBm
RF to IF Output Isolation			-22		dB
IF/2 Spurious	–10 dBm input power		-72		dBc
IF/3 Spurious	–10 dBm input power		-69		dBc
POWER INTERFACE					
VCC12, VCC7, VCC2, VCC1					
Supply Voltage		3.55	3.7	3.85	V
Quiescent Current			260		mA
VCC3, VCC4, VCC5, VCC6, VCC8, VCC9, VCC10, VCC11, IFOUT1+, IFOUT1–,					
IFOUT2+, IFOUT2-					
Supply Voltage		3.55	5	5.25	V
Quiescent Current			214		mA
LO OUTPUT (LOOUT+, LOOUT–)					
Frequency Range		200		2700	MHz
Output Level	Adjustable via SPI in four steps, in 50 $\Omega$ balanced load	-5		+7	dBm
Output Impedance	Balanced		50		Ω

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<sup>1</sup> Supply voltage must be applied from the external circuit through choke inductors.

 $T_A = 25^{\circ}$ C,  $f_{RF} = 1900$  MHz,  $f_{LO} = 1697$  MHz,  $Z_O = 50 \Omega$ ,  $f_{REF} = 122.88$  MHz,  $f_{REF}$  power = 4 dBm,  $f_{PFD} = 1.536$  MHz, low-side LO injection, optimum RFB and LPF settings, unless otherwise noted.

#### Table 2. High Efficiency Mode

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
DYNAMIC PERFORMANCE					
Power Conversion Gain	4:1 IF port transformer and PCB loss removed		8.7		dB
Voltage Conversion Gain	$Z_{\text{SOURCE}} = 50 \Omega$ , differential $Z_{\text{LOAD}} = 200 \Omega$		14.7		dB
SSB Noise Figure			10.7		dB
Input Third-Order Intercept (IIP3)	$f_{\text{RF1}}$ = 1900 MHz, $f_{\text{RF2}}$ = 1901 MHz, $f_{\text{LO}}$ = 1697 MHz, each RF tone at $-10$ dBm		20.5		dBm
Input Second-Order Intercept (IIP2)	$f_{\text{RF1}}$ = 1900 MHz, $f_{\text{RF2}}$ = 1950 MHz, $f_{\text{LO}}$ = 1697 MHz, each RF tone at $-10$ dBm		53		dBm
Input 1 dB Compression Point (P1dB)			8.2		dBm
LO to IF Output Leakage	Unfiltered IF output		-45.0		dBm
LO to RF Input Leakage			-52.0		dBm
RF to IF Output Isolation			-22.8		dB
IF/2 Spurious	–10 dBm input power		-58		dBc
IF/3 Spurious	–10 dBm input power		-58		dBc
POWER INTERFACE					
VCC12, VCC7, VCC2, VCC1					
Supply Voltage		3.55	3.7	3.85	V
Quiescent Current			260		mA
VCC3, VCC4, VCC5, VCC6, VCC8, VCC9, VCC10, VCC11, IFOUT1+, IFOUT1–, IFOUT2+, IFOUT2–					
Supply Voltage		3.55	3.7	5.25	V
Quiescent Current			210		mA

#### SYNTHESIZER/PLL SPECIFICATIONS

High performance mode,  $T_A = 25^{\circ}$ C, measured on LO output,  $f_{LO} = 1700$  MHz,  $Z_O = 50 \Omega$ ,  $f_{REF} = 122.88$  MHz,  $f_{PFD} = 1.536$  MHz,  $f_{REF}$  power = 4 dBm, CSCALE = 8 mA, bleed = 0  $\mu$ A, ABLDLY = 0.9 ns, integer mode loop filter, unless otherwise noted.

Table 3	Integer	Mode
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Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
SYNTHESIZER SPECIFICATIONS	Synthesizer specifications referenced to 1 × LO				
Frequency Range	Internally generated LO	200		2700	MHz
Figure of Merit (FOM) <sup>1</sup>	$P_{\text{REFIN}} = 6.5 \text{ dBm}$		-223		dBc/Hz/Hz
Phase and Frequency Detector (PFD) Frequency (f <sub>PFD</sub> )		0.8		70	MHz
Reference Spurs	f <sub>PFD</sub> = 1.536 MHz				
	$1 \times f_{PFD}$		-105		dBc
	$4 \times f_{PFD}$		-105		dBc
	$>4 \times f_{PFD}$		-90		dBc
CHARGE PUMP					
Pump Current	Programmable to 250 μΑ, 500 μΑ,, 8 mA		8	8.75	mA
Output Compliance Range		0.7		2.5	V
REFERENCE CHARACTERISTICS	REFIN, MUXOUT pins				
REFIN Input Frequency		12		320	MHz
REFIN Input Capacitance			4		pF
Reference Divider Value	Programmable to 0.5, 1, 2, 3,, 2047	0.5		2047	
MUXOUT Output Level	VOL (lock detect output selected)			0.25	V
	VOH (lock detect output selected)	2.7			V
MUXOUT Duty Cycle	Reference output selected		50		%

**Data Sheet** 

# ADRF6612

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
VCO_0			· ·		
Phase Noise, Locked	$f_{LO} = 5.1 \text{ GHz}$				
	1 kHz offset		-87		dBc/Hz
	50 kHz offset		-94.9		dBc/Hz
	100 kHz offset		-103.3		dBc/Hz
	1 MHz offset		-132.9		dBc/Hz
	10 MHz offset		-154.1		dBc/Hz
	40 MHz offset		-155.2		dBc/Hz
Integrated Phase Noise	1 kHz to 40 MHz integration bandwidth		0.87		°rms
VCO_1					
Phase Noise, Locked	$f_{LO} = 4.45 \text{ GHz}$				
	1 kHz offset		-90		dBc/Hz
	50 kHz offset		-98.4		dBc/Hz
	100 kHz offset		-106.5		dBc/Hz
	1 MHz offset		-136.1		dBc/Hz
	10 MHz offset		-154.8		dBc/Hz
	40 MHz offset		-155.5		dBc/Hz
Integrated Phase Noise	1 kHz to 40 MHz integration bandwidth		0.63		°rms
VCO_2					
Phase Noise, Locked	$f_{LO} = 3.8 \text{ GHz}$				
	1 kHz offset		-90		dBc/Hz
	50 kHz offset		-98.1		dBc/Hz
	100 kHz offset		-109.8		dBc/Hz
	1 MHz offset		-137.1		dBc/Hz
	10 MHz offset		-155.7		dBc/Hz
	40 MHz offset		-156.2		dBc/Hz
Integrated Phase Noise	1 kHz to 40 MHz integration bandwidth		0.61		°rms
VCO_3					
Phase Noise, Locked	$f_{LO} = 3.2 \text{ GHz}$				
	1 kHz offset		-89		dBc/Hz
	50 kHz offset		-97.2		dBc/Hz
	100 kHz offset		-107		dBc/Hz
	1 MHz offset		-136.2		dBc/Hz
	10 MHz offset		-155.7		dBc/Hz
	40 MHz offset		-157.3		dBc/Hz
Integrated Phase Noise	1 kHz to 40 MHz integration bandwidth		0.64		°rms

<sup>1</sup> The FOM is computed as phase noise (dBc/Hz) – 10Log10(f<sub>PFD</sub>) – 20Log10(f<sub>LO</sub>/f<sub>PFD</sub>). The FOM was measured across the full LO range, with f<sub>REF</sub> = 122.88 MHz and f<sub>REF</sub> power = 6.5 dBm with a 1.536 MHz f<sub>PFD</sub>. The FOM was computed at 50 kHz offset.

$High \ performance \ mode, T_{A} = 25^{\circ}C, \ measured \ on \ LO \ output, \ f_{LO} = 1700 \ MHz, \ Z_{O} = 50 \ \Omega, \ f_{REF} = 122.88 \ MHz, \ f_{PFD} = 30.72 \ MHz, \ f_{REF} \ power \ normalized \ model{eq:entropy}$	:=
4 dBm, CSCALE = 250 $\mu$ A, bleed = 93.75 $\mu$ A, ABLDLY = 0 ns, fractional mode loop filter, unless otherwise noted.	

Table 4. Flactional Mode				
Parameter	Test Conditions/Comments	Min	Тур Мах	Unit
SYNTHESIZER SPECIFICATIONS	Synthesizer specifications referenced to $1 \times LO$			
FOM <sup>1</sup>	$P_{\text{REFIN}} = 6.5 \text{ dBm}$		219	dBc/Hz/Hz
REFERENCE CHARACTERISTICS	REFIN, MUXOUT pins			
VCO_0				
Phase Noise, Locked	f <sub>LO</sub> = 2.55 GHz			
	1 kHz offset		-92.5	dBc/Hz
	50 kHz offset		-97.4	dBc/Hz
	100 kHz offset		-109.7	dBc/Hz
	1 MHz offset		-137.6	dBc/Hz
	10 MHz offset		-153.6	dBc/Hz
	40 MHz offset		-155.5	dBc/Hz
Integrated Phase Noise	1 kHz to 40 MHz integration bandwidth		0.36	°rms
VCO_1				
Phase Noise, Locked	$f_{LO} = 2.22 \text{ GHz}$			
	1 kHz offset		-93.6	dBc/Hz
	50 kHz offset		-101.8	dBc/Hz
	100 kHz offset		-112.5	dBc/Hz
	1 MHz offset		-140.5	dBc/Hz
	10 MHz offset		-154.3	dBc/Hz
	40 MHz offset		-155.3	dBc/Hz
Integrated Phase Noise	1 kHz to 40 MHz integration bandwidth		0.32	°rms
VCO_2	$f_{LO} = 1.9 \text{ GHz}$			
Phase Noise, Locked	1 kHz offset		-94.2	dBc/Hz
	50 kHz offset		-101.7	dBc/Hz
	100 kHz offset		-112.4	dBc/Hz
	1 MHz offset		-141.3	dBc/Hz
	10 MHz offset		-155.8	dBc/Hz
	40 MHz offset		-156.8	dBc/Hz
	1 kHz to 40 MHz integration bandwidth		0.32	°rms
Integrated Phase Noise				
VCO_3	$f_{LO} = 1.6 \text{ GHz}$			
Phase Noise, Locked	1 kHz offset		-93.1	dBc/Hz
	50 kHz offset		-99.8	dBc/Hz
	100 kHz offset		-110.9	dBc/Hz
	1 MHz offset		-140.2	dBc/Hz
	10 MHz offset		-155.7	dBc/Hz
	40 MHz offset		-157.2	dBc/Hz
	1 kHz to 40 MHz integration bandwidth		0.33	°rms

Table 4. Fractional Mode

<sup>1</sup> The FOM is computed as phase noise (dBc/Hz) – 10Log10(f<sub>PFD</sub>) – 20Log10(f<sub>LO</sub>/f<sub>PFD</sub>). The FOM was measured across the full LO range, with f<sub>REF</sub> = 122.88 MHz and f<sub>REF</sub> power = 6.5 dBm with a 30.72 MHz f<sub>PFD</sub>. The FOM was computed at 45 kHz offset.

### VCO SPECIFICATIONS, OPEN-LOOP

High performance mode,  $T_A = 25^{\circ}$ C, measured on LO output, unless otherwise noted.

### Table 5.

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
VCO_0 PHASE NOISE	f <sub>vco</sub> = 5.15 GHz				
	1 kHz offset		-50		dBc/Hz
	50 kHz offset		-104.4		dBc/Hz
	100 kHz offset		-112.6		dBc/Hz
	1 MHz offset		-137.7		dBc/Hz
	10 MHz offset		-154		dBc/Hz
	40 MHz offset		-155.1		dBc/Hz
VCO_1 PHASE NOISE	$f_{VCO} = 4.3 \text{ GHz}$				
	1 kHz offset		-54		dBc/Hz
	50 kHz offset		-106.1		dBc/Hz
	100 kHz offset		-115		dBc/Hz
	1 MHz offset		-138.9		dBc/Hz
	10 MHz offset		-155.8		dBc/Hz
	40 MHz offset		-155.2		dBc/Hz
VCO_2 PHASE NOISE	$f_{VCO} = 3.8 \text{ GHz}$				
	1 kHz offset		-53.6		dBc/Hz
	50 kHz offset		-106.6		dBc/Hz
	100 kHz offset		-114.6		dBc/Hz
	1 MHz offset		-140.8		dBc/Hz
	10 MHz offset		-155.4		dBc/Hz
	40 MHz offset		-156.3		dBc/Hz
VCO_3 PHASE NOISE	$f_{VCO} = 3.2 \text{ GHz}$				
	1 kHz offset		-48.5		dBc/Hz
	50 kHz offset		-106		dBc/Hz
	100 kHz offset		-115.3		dBc/Hz
	1 MHz offset		-140.2		dBc/Hz
	10 MHz offset		-157.7		dBc/Hz
	40 MHz offset		-156.3		dBc/Hz

#### LOGIC INPUT AND POWER SPECIFICATIONS

 $T_A = 25^{\circ}$ C,  $f_{RF} = 1900$  MHz,  $f_{LO} = 1697$  MHz,  $Z_O = 50 \Omega$ ,  $f_{REF} = 122.88$  MHz,  $f_{REF}$  power = 4 dBm,  $f_{PFD} = 1.536$  MHz, low-side LO injection, optimum RFB and LPF settings, unless otherwise noted.

#### Table 6.

Parameter	Test Conditions/Comments	Min	Тур	Max	Unit
LOGIC INPUTS	SCLK, SDIO, CS				
Input High Voltage, V <sub>⊪</sub>		1.4		3.3	V
Input Low Voltage, V⊾		0		0.7	V
Input Current, I <sub>INH</sub> /I <sub>INL</sub>			0.1		μA
POWER SUPPLIES					
High Performance Mode					
Voltage Range					
VCC3, VCC4, VCC5, VCC6, VCC8, VCC9, VCC10, VCC11, IFOUT1+, IFOUT1-, IFOUT2+, IFOUT2-		4.75	5	5.25	V
VCC12, VCC7, VCC2, VCC1		3.55	3.7	5.25	V
Power Dissipation	Internal LO mode (internal PLL)				
	External LO output enabled		2.7		W
	External LO output disabled		2.5		W
High Efficiency Mode					
Voltage Range					
VCC1, VCC2, VCC3, VCC4, VCC5, VCC6, VCC7, VCC8, VCC9, VCC10, VCC11,VCC12, IFOUT1+, IFOUT1-, IFOUT2+, IFOUT2-		3.55	3.7	3.85	V
Power Dissipation	Internal LO mode (internal PLL)				
	External LO output enabled		2.0		W
	External LO output disabled		1.8		W

#### DIGITAL LOGIC SPECIFICATIONS

#### Table 7.

Parameter	Symbol	Test Conditions/Comments	Min	Тур	Max	Units
Input Voltage High	VIH		1.4			V
Input Voltage Low	VIL				0.70	V
Output Voltage High	Vон	Іон = −100 μА	2.3			V
Output Voltage Low	Vol	$I_{OL} = 100 \ \mu A$			0.2	V
Serial Clock Period	<b>t</b> clk		38			ns
Setup Time Between Data and Rising Edge of SCLK	t <sub>DS</sub>		8			ns
Hold Time Between Data and Rising Edge of SCLK	t <sub>DH</sub>		8			ns
Setup Time Between Falling Edge of CS and SCLK	ts		10			ns
Hold Time Between Rising Edge of $\overline{CS}$ and SCLK	tн		10			ns
Minimum Period for SCLK to Be in a Logic High State	tнідн		10			ns
Minimum Period for SCLK to Be in a Logic Low State	t <sub>LOW</sub>		10			ns
Maximum Delay Between Falling Edge of SCLK and Output Data Valid for a Read Operation	taccess				231	ns
Maximum Delay Between CS Deactivation and SDIO	tz				5	ns
Bus Return to High Impedance						



Figure 2. Setup and Hold Timing Measurements

### **ABSOLUTE MAXIMUM RATINGS**

#### Table 8.

Parameter	Rating
Supply Voltage (VCC1, VCC2, VCC3,	–0.5 V to +5.5 V
VCC4, VCC5, VCC6, VCC7, VCC8, VCC9,	
VCC10, VCC11, VCC12, IFOUT1+,	
IFOUT1–, IFOUT2+, IFOUT2–)	
Digital Input/Output (SCLK, SDIO, CS)	–0.3 V to +3.6 V
RFINx	20 dBm
EXTVCOIN+, EXTVCOIN-	13 dBm
Maximum Junction Temperature	150°C
Operating Temperature Range	-40°C to +85°C
Storage Temperature Range	–65°C to +150°C

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

#### THERMAL RESISTANCE

 $\theta_{\rm JC}$  is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages.

#### **Table 9. Thermal Resistance**

Package Type	θ」	Unit
48-Lead LFCSP	1.62	°C/W

#### **ESD CAUTION**



**ESD** (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

# **PIN CONFIGURATION AND FUNCTION DESCRIPTIONS**



#### Table 10. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	GND	Common Ground Connection for External Loop Filter.
2	VCOVTUNE	Control Voltage for Internal VCO.
3, 6	GND	Common Ground for External VCO.
4, 5	EXTVCOIN+, EXTVCOIN-	Inputs from External VCO to Internal Divider.
7	VCC1	3.7 V VCO Supply.
8, 9	DECL1, DECL2	LDO Output Decouplers for VCO.
10, 11	DECL3, DECL4	External Decouplers for VCO Buffer.
12	DECL5	External Decoupler for VCO Circuitry.
13, 14	LOOUT+, LOOUT-	Differential Outputs of Internally Generated LO.
15	LDO1	External Decoupling for Internal 2.5 V SPI Port LDO.
16	VCC2	3.7 V Supply for Programmable SPI Port.
17	SDIO	Serial Data Input/Output for Programmable SPI Port.
18	SCLK	Clock for Programmable SPI Port.
19	CS	SPI Chip Select, Asserted Low.
20, 41	VCC3, VCC11	5 V Biases for Channel 1 and Channel 2 IF.
21, 40	DNC	Do Not Connect. Do not connect this pin externally.
22, 23	IFOUT2+, IFOUT2-	Channel 2 Differential IF Outputs.
24, 37	GND, GND	Ground Connections for Channel 1 and Channel 2 IF Stage.
25	RFBCT2	Balun Center Tap Connection for Channel 2 RF Input.
26	RFIN2	Channel 2 RF Input.
27, 28, 29	VCC4, VCC5, VCC6	5 V Supplies for Mixer LO Amplifiers.
30	LDO2	External Decoupling for Internal 3.3 V PLL/Divider LDO.
31	VCC7	3.7 V Supply for Mixer LO Divider Chain.
32, 33, 34	VCC8, VCC9, VCC10	5 V Supplies for Mixer LO Amplifiers.
35	RFIN1	Channel 1 RF Input.
36	RFBCT1	Balun Center Tap Connection for Channel 1 RF Input.
38, 39	IFOUT1-, IFOUT1+	Channel 1 Differential IF Outputs.
42	MUXOUT	Internal Multiplexer Output.

Pin No.	Mnemonic	Description
43	REFIN	Reference Input for Internal PLL (Single-Ended, CMOS).
44	LDO3	External Decoupling for Internal 2.5 V PLL LDO.
45	LDO4	External Decoupling for Internal 3.3 V PLL LDO.
46	VCC12	3.7 V Supply for Internal PLL.
47	CPOUT	Charge Pump Output.
48	GND	Common Ground for External Charge Pump.
	EPAD	Exposed Pad. The exposed pad must be connected to a ground plane with low thermal impedance.

### **TYPICAL PERFORMANCE CHARACTERISTICS**

#### **MIXER, HIGH PERFORMANCE MODE**

 $T_A = 25^{\circ}$ C,  $f_{RF} = 1900$  MHz,  $f_{LO} = 1697$  MHz,  $Z_O = 50 \Omega$ ,  $f_{REF} = 122.88$  MHz,  $f_{REF}$  power = 4 dBm, low-side LO injection, optimum RFB and LPF settings, unless otherwise noted. For integer mode:  $f_{PFD} = 1.536$  MHz, CSCALE = 8 mA, bleed = 0  $\mu$ A, ABLDLY = 0.9 ns. For fractional mode:  $f_{PFD} = 30.72$  MHz, CSCALE = 250  $\mu$ A, bleed = 93.75  $\mu$ A, ABLDLY = 0.0 ns.



Figure 4. Power Dissipation vs. RF Frequency over Three Temperatures



Figure 5. Power Conversion Gain vs. RF Frequency over Three Temperatures, IF Balun and Board Loss Removed



Figure 6. Input IP3 vs. RF Frequency over Three Temperatures



Figure 7. Input IP2 vs. RF Frequency over Three Temperatures



Figure 8. Input P1dB vs. RF Frequency over Three Temperatures







Figure 10. Power Dissipation vs. Temperature for Three RF Frequencies



Figure 11. Power Conversion Gain vs. Temperature for Three RF Frequencies



Figure 12. Input IP3 vs. Temperature for Three RF Frequencies



Figure 13. Input IP2 vs. Temperature for Three RF Frequencies



Figure 14. Input P1dB vs. Temperature for Three RF Frequencies



Figure 15. SSB Noise Figure vs. Temperature for Three RF Frequencies

### **Data Sheet**



Figure 16. Power Dissipation vs. IF Frequency for Three RF Frequencies



Figure 17. Power Conversion Gain vs. IF Frequency for Three RF Frequencies



Figure 18. Input IP3 vs. IF Frequency for Three RF Frequencies



Figure 19. Input IP2 vs. IF Frequency for Three RF Frequencies



Figure 20. Input P1dB vs. IF Frequency for Three RF Frequencies



Figure 21. SSB Noise Figure vs. IF Frequency for Three RF Frequencies



Figure 22. IF/2 Spurious vs. RF Frequency over Three Temperatures



Figure 23. IF/3 Spurious vs. RF Frequency over Three Temperatures



Figure 24. RF to IF Isolation vs. RF Frequency over Three Temperatures



Figure 25. LO to IF Leakage vs. LO Frequency over Three Temperatures



Figure 26. LO to RF Leakage vs. LO Frequency over Three Temperatures



Figure 27. 2  $\times$  LO Leakage vs. LO Frequency (2  $\times$  LO to RF and 2  $\times$  LO to IF)

### **Data Sheet**





Figure 34. IF Output Impedance (R Parallel C Equivalent)



Figure 35. Conversion Gain vs. RF Frequency for All RFB Settings, VGS and LPF Use Optimum Settings







Figure 37. IF Channel-to-Channel Isolation vs. RF Frequency over Three Temperatures



Figure 38. Input IP3 vs. RF Frequency for All RFB Settings, VGS and LPF Use Optimum Settings



Figure 39. SSB Noise Figure vs. RF Frequency for All RFB Settings, VGS and LPF Use Optimum Settings

### **Data Sheet**





Figure 47. Power Dissipation vs. Temperature for IF Main Settings



Figure 48. Power Dissipation vs. Temperature for IF LIN Settings



Figure 49. SSB Noise Figure vs. RF Frequency for All LPF Settings, RFB and VGS Use Optimum Settings







Figure 51. Input IP3 vs. Temperature for IF LIN Settings

### **Data Sheet**

#### -60 890MHz +10dBm 1910MHz +10dBm 2510MHz +10dBm -70 1111 -80 –90 –100 E (dBc/Hz) –110 –110 –120 –130 11 11 ľT -110 N -140 -150 -160 L 0.001 12199-352 0.01 0.1 1 10 OFFSET FREQUENCY (MHz)

Figure 52. Phase Noise at IF Output vs. Offset Frequency with 10 dBm Blocker in Integer Mode



Figure 53. Phase Noise at IF Output vs. Offset Frequency with 10 dBm Blocker in Fractional Mode

#### **MIXER, HIGH EFFICIENCY MODE**

 $T_A = 25^{\circ}$ C,  $f_{RF} = 1900$  MHz,  $f_{LO} = 1697$  MHz,  $Z_O = 50 \Omega$ ,  $f_{REF} = 122.88$  MHz,  $f_{REF}$  power = 4 dBm,  $f_{PFD} = 1.536$  MHz, low-side LO injection, optimum RFB and LPF settings, unless otherwise noted.



Figure 54. Power Dissipation vs. RF Frequency over Three Temperatures



Figure 55. Conversion Gain vs. RF Frequency over Three Temperatures



Figure 56. Input IP3 vs. RF Frequency over Three Temperatures



Figure 57. Input IP2 vs. RF Frequency over Three Temperatures



Figure 58. Input P1dB vs. RF Frequency over Three Temperatures



Figure 59. SSB Noise Figure vs. RF Frequency over Three Temperatures

#### SYNTHESIZER

 $V_s$  = high performance mode,  $T_A$  = 25°C, measured on LO output,  $f_{LO}$  = 1700 MHz,  $Z_O$  = 50  $\Omega$ ,  $f_{REF}$  = 122.88 MHz,  $f_{PFD}$  = 1.536 MHz,  $f_{REF}$  power = 4 dBm, integer mode loop filter, unless otherwise noted.







Figure 61. VCO\_1 Open-Loop Phase Noise vs. Offset Frequency,  $f_{VCO_1} = 4.5$  GHz, Divide by Two Selected, VCOVTUNE = 1.5 V



Figure 62. VCO\_2 Open-Loop Phase Noise vs. Offset Frequency,  $f_{VCO_2}$  = 3.8 GHz, Divide by Two Selected, VCOVTUNE = 1.5 V



Figure 63. VCO\_0 Closed-Loop Phase Noise for Various LO\_DIV Dividers vs. Offset Frequency,  $f_{VCO_0} = 5.1 \text{ GHz}$ 



Figure 64. VCO\_1 Closed-Loop Phase Noise for Various LO\_DIV Dividers vs. Offset Frequency, fvco\_1 = 4.5 GHz



Figure 65. VCO\_2 Closed-Loop Phase Noise for Various LO\_DIV Dividers vs. Offset Frequency,  $f_{VCO_22} = 3.8 \text{ GHz}$ 



### Figure 66. VCO\_3 Open-Loop Phase Noise vs. Offset Frequency, $f_{VCO_3}$ = 3.2 GHz, Divide by Two Selected, VCOVTUNE = 1.5 V



Figure 67. PLL Figure of Merit (FOM) vs. LO Frequency, Integer Mode



Divide by Two Selected



Figure 69. VCO\_3 Closed-Loop Phase Noise for Various LO\_DIV Dividers vs. Offset Frequency,  $f_{VCO_3} = 3.2 \text{ GHz}$ 



Figure 70. PLL Figure of Merit (FOM) vs. LO Frequency, Fractional Mode Offset = 45 kHz, Bleed = 125 µA



Figure 71. Open-Loop Phase Noise vs. LO Frequency, Divide by Two Selected

### **Data Sheet**



Figure 72. Integer Loop Filter Phase Noise, Divide by Two Selected, Offset = 1 kHz, 100 kHz, 500 kHz, and 10 MHz



Figure 73. 10 kHz to 40 MHz Integrated Phase Noise vs. VCO Frequency, Divide by Two, Four, and Eight, Including Spurs



Figure 74. f<sub>PFD</sub> Reference Spurs vs. VCO Frequency, 1 × PFD Offset, Measured at LO Output, Integer Mode



Figure 75. Integer Loop Filter Phase Noise, Divide by Two Selected, Offset = 50 kHz, 200 kHz, 1 MHz, and 40 MHz



Figure 76. 10 kHz to 40 MHz Integrated Phase Noise vs. VCO Frequency, Divide by Two, Four, and Eight, Excluding Spurs



Figure 77.  $f_{PFD}$  Reference Spurs vs. VCO Frequency, 2 × PFD Offset, Measured at LO Output, Integer Mode

12199-078

5360

2630

2630

2830 2199-382

12199-383

2830



### Data Sheet



Figure 84.  $f_{PFD}$  Reference Spurs vs. LO Frequency, Divide by Two Selected, 1 × PFD Offset, Measured on LO Output and IF Output



Figure 85. LO Amplitude vs. LO Frequency, LO\_DRV\_LVL = 0, 1, 2, and 3









Figure 88. LO Frequency Settling Time, Integer Mode Loop Filter, Integer Mode



Figure 89. LO Frequency Settling Time, Fractional Loop Filter, Fractional Mode



Figure 90.  $V_{TUNE}$  vs. LO Frequency for Lock at Cold Drift to Hot



Figure 91. V<sub>TUNE</sub> vs. LO Frequency for Lock at Hot Drift to Cold



Figure 92. PFD Spurs vs. Offset Frequency for 4 VCOs, Integer Mode

#### **SPURIOUS PERFORMANCE**

 $(N \times f_{RF}) - (M \times f_{LO})$  spur measurements were made using the standard evaluation board. Mixer spurious products are measured in dBc from the IF output power level. Data was measured only for frequencies less than 6 GHz. Typical noise floor of the measurement system = -100 dBm.

#### High Performance Mode

 $V_s$  = high performance mode,  $T_A$  = 25°C,  $Z_O$  = 50  $\Omega$ ,  $f_{REF}$  = 122.88 MHz,  $f_{REF}$  power = 4 dBm,  $f_{PFD}$  = 1.536 MHz, low-side LO injection, optimum RFB and LPF settings, unless otherwise noted.

#### Μ 2 3 8 0 1 4 5 6 7 9 -27.1 -32.1 -39.1 -27.0 -54.2 -48.5 -69.3 -65.6 0 -35.5 0.0 -52.5 -18.4 -56.6 -43.6 -66.7 -53.5 -87.4 -73.5 1 -55.3 -68.9 -68.8 -73.4 -64.9 <-100 -68.3 <-100 -80.6 <-100 2 -88.2 -88.4 <-100 -79.5 <-100 <-100 <-100 3 -94.1 <-100 <-100 4 <-100 -56.6 <-100 <-100 <-100 <-100 <-100 <-100 <-100 <-100 Ν <-100 -43.6 <-100 <-100 <-100 <-100 5 <-100 <-100 <-100 <-100 <-100 -66.7 <-100 <-100 <-100 <-100 <-100 <-100 <-100 <-100 6 7 <-100 <-100 <-100 <-100 <-100 <-100 -53.5 <-100 <-100 8 <-100 <-100 <-100 <-100 <-100 <-100 <-100 <-100 9 <-100 <-100 <-100 <-100 <-100 <-100

#### Table 11. RF = 900 MHz, LO = 697 MHz

#### Table 12. RF = 1900 MHz, LO = 1697 MHz

			Μ									
		0	1	2	3	4	5	6	7	8	9	
	0		-37.0	-31.2	-64.2							
	1	-30.2	0.0	-47.9	-52.1	-74.4						
	2	-70.8	-71.9	-81.6	-81.2	-67.2	<-100					
	3	<-100	<-100	-93.5	-75.2	<-100	<-100	<-100				
N	4		<-100	<-100	<-100	<-100	<-100	<-100	<-100	<-100		
IN	5				<-100	<-100	<-100	<-100	<-100	<-100	<-100	
	6					<-100	<-100	<-100	<-100	<-100	<-100	
	7						<-100	<-100	<-100	<-100	<-100	
	8							<-100	<-100	<-100	<-100	
	9								<-100	<-100	<-100	

#### Table 13. RF = 2500 MHz, LO = 2297 MHz

			M									
		0	1	2	3	4	5	6	7	8	9	
	0		-40.7	-44.1								
	1	-29.0	0.0	-49.4	-58.7							
	2	-81.0	-87.3	-75.4	-79.0	-84.7						
	3		<-100	-91.9	-74.7	<-100	<-100					
N	4			<-100	<-100	<-100	<-100	<-100				
	5				<-100	<-100	<-100	<-100	<-100	<-100		
	6					<-100	<-100	<-100	-92.5	<-100	<-100	
	7							<-100	<-100	<-100	<-100	
	8								<-100	<-100	<-100	
	9									<-100	<-100	

#### High Efficiency Mode

 $V_s$  = high efficiency mode,  $T_A$  = 25°C,  $Z_O$  = 50  $\Omega$ ,  $f_{REF}$  = 122.88 MHz,  $f_{REF}$  power = 4 dBm,  $f_{PFD}$  = 1.536 MHz, low-side LO injection, optimum RFB and LPF settings, unless otherwise noted.

#### Table 14. RF = 900 MHz, LO = 697 MHz

			M									
		0	1	2	3	4	5	6	7	8	9	
	0		-30.4	-34.1	-46.7	-29.6	-57.4	-51.2	-74.7	-62.7		
	1	-37.7	0.0	-52.6	-19.2	-61.6	-44.3	-64.0	-53.6	-91.8	-73.2	
	2	-70.3	-66.4	-68.8	-71.9	-59.9	-93.0	-67.8	<-100	-79.0	<-100	
	3	-86.4	-81.0	-96.4	-74.7	<-100	-85.0	<-100	<-100	<-100	<-100	
N	4	<-100	<-100	-97.9	<-100	<-100	<-100	<-100	<-100	<-100	<-100	
IN	5	<-100	<-100	<-100	<-100	<-100	<-100	<-100	<-100	<-100	<-100	
	6	<-100	<-100	<-100	<-100	<-100	<-100	<-100	<-100	<-100	<-100	
	7		<-100	<-100	<-100	<-100	<-100	<-100	<-100	<-100	<-100	
	8			<-100	<-100	<-100	<-100	<-100	<-100	<-100	<-100	
	9					<-100	<-100	<-100	<-100	<-100	<-100	

#### Table 15. RF = 1900 MHz, LO = 1697 MHz

			Μ									
		0	1	2	3	4	5	6	7	8	9	
	0		-41.4	-35.1	-69.0							
	1	-30.5	0.0	-46.9	-52.2	-74.4						
	2	-71.5	-67.7	-74.6	-71.3	-63.6	<-100					
	3	<-100	<-100	-89.9	-67.7	<-100	<-100	<-100				
N	4		<-100	<-100	<-100	<-100	<-100	<-100	<-100	<-100		
IN	5				<-100	<-100	<-100	<-100	<-100	<-100	<-100	
	6					<-100	<-100	<-100	<-100	<-100	<-100	
	7						<-100	<-100	<-100	<-100	<-100	
	8							<-100	<-100	<-100	<-100	
	9								<-100	<-100	<-100	

#### Table 16. RF = 2500 MHz, LO = 2297 MHz

			M									
		0	1	2	3	4	5	6	7	8	9	
	0		-42.3	-48.6								
	1	-29.1	0.0	-48.6	-59.4							
	2	-75.6	-88.8	-71.6	-70.8	-77.0						
	3		-59.4	-86.2	-66.9	<-100	<-100					
NI	4			-77.0	<-100	<-100	<-100	<-100				
IN	5				<-100	<-100	<-100	<-100	<-100	<-100		
	6					<-100	<-100	<-100	<-100	<-100	<-100	
	7							<-100	<-100	<-100	<-100	
	8								<-100	<-100	<-100	
	9									<-100	<-100	

### **CIRCUIT DESCRIPTION**

The ADRF6612 consists of two primary components: the RF subsystem and the LO subsystem. The combination of design, process, and packaging technology allows the functions of these subsystems to be integrated into a single die, using mature packaging and interconnection technologies to provide a high performance device with excellent electrical, mechanical, and thermal properties. The wideband frequency response and flexible frequency programming simplifies the receiver design, saves on-board space, and minimizes the need for external components.

The RF subsystem consists of an integrated, tunable, low loss RF balun, a double balanced, passive MOSFET mixer, a tunable sum termination network, and an IF amplifier.

The LO subsystem consists of a multistage, limiting LO amplifier. The purpose of the LO subsystem is to provide a large, fixed amplitude, balanced signal to drive the mixer independent of the level of the LO input. A schematic of the device is shown in Figure 94.

#### **RF SUBSYSTEM**

The single-ended, 50  $\Omega$  RF input is internally transformed to a balanced signal using a tunable, low loss, unbalanced-to-balanced (balun) transformer. This transformer is made possible by an extremely low loss metal stack, which provides both excellent balance and dc isolation for the RF port. Although the port can be dc connected, it is recommended to use a blocking capacitor to avoid running excessive dc current through the device. The RF balun can easily support an RF input frequency range of 700 MHz to 3000 MHz. This balun is tuned over the frequency range by a SPI controlled switched capacitor network at the output of the RF balun.

The resulting balanced RF signal is applied to a passive mixer that commutates the RF input in accordance with the output of the LO subsystem. The passive mixer is a balanced, low loss switch that adds minimum noise to the frequency translation. The only noise contribution from the mixer is due to the resistive loss of the switches, which is in the order of a few ohms.

The IF amplifier is a balanced feedback design that simultaneously provides the desired gain, noise figure, and input impedance that is required to achieve the overall performance. The balanced open-collector output of the IF amplifier, with an impedance modified by the feedback within the amplifier, permits the output to be connected directly to a high impedance filter, a differential amplifier, or an analog-to-digital converter (ADC) input while providing optimum second-order intermodulation suppression. The differential output impedance of the IF amplifier is approximately 200  $\Omega$ . If operation in a 50  $\Omega$  system is desired, the output can be transformed to 50  $\Omega$  by using a 4:1 transformer or an LC impedance matching network.

#### **EXTERNAL LO GENERATION**

The ADRF6612 LO can be generated by an externally applied source or by using the internal PLL synthesizer.

To select the external LO mode, write the value 011 to Register 0x22, Bits[2:0] and apply the differential LO signal to Pin 4 (EXTVCOIN+) and Pin 5 (EXTVCOIN–).

Internal dividers allow the externally applied LO signal to be divided before this signal arrives at the mixer LO input. The divider value is set by Register 0x21, Bits[5:3] and has possible values of 1, 2, 4, and 8. With the divider set to 1, the externally applied LO input frequency range is 250 MHz to 2850 MHz. When using a divider value of other than 1, the maximum externally applied LO frequency is 5700 MHz.

The external LO input pins present a broadband differential 50  $\Omega$  input impedance. The EXTVCOIN+ and EXTVCOIN– input pins must be ac-coupled. When not in use, EXTVCOIN+ and EXTVCOIN– can be left unconnected.

#### INTERNAL LO GENERATION Reference Input Circuitry

The ADRF6612 includes an on-chip PLL for LO synthesis. The PLL, shown in Figure 93, consists of a reference input and input dividers, a PFD, a charge pump, VCOs, and a programmable fractional/integer divider with a 2× prescaler.

The reference path takes in a reference clock and divides it by a factor of 1 to 8191 before passing it to the PFD. The PFD compares this signal to the divided down signal from the VCO. Depending on the PFD polarity selected, the PFD sends an up or down signal to the charge pump if the VCO signal is slow or fast compared to the reference frequency. The charge pump sends a current pulse to the off-chip loop filter to increase or decrease the tuning voltage (VCOVTUNE).

In band (within the band of the loop filter) phase noise performance is typically limited by the reference source. Due to the inherent phase noise reduction when performing frequency division, improved in band phase noise performance can be achieved with higher reference divide values. However, the divide chain adds its own small amount of phase noise, so there is a limit on how much improvement can be gained by increasing the divider value.



Figure 93. LO Generation Block Diagram

#### **Loop Filters**

Defining a loop filter for the ADRF6612 depends on several dynamics, these being the PLL REFIN and PFD frequency and desired PFD and fractional spur levels. Higher reference and PFD frequencies spread the PFD spurs over a wider bandwidth (wider separation between spurs), but also lead to higher levels of spurs coupling through the reference divider chain. Lower reference and PFD frequencies lower the spacing between PFD spurs, but the spur levels can be significantly improved by using lower frequencies. At lower PFD frequencies, it may also be possible to achieve the desired synthesizer frequency step size using the integer divider mode, therefore eliminating the risk of fractional spurs. Table 17 shows the recommended loop filter components and dynamic loop settings when using integer mode and PFD frequencies at less than 10 MHz.

# Table 17. Integer Mode Loop Filter Components and PLLDynamic Settings

Loop Filter Components	PLL Dynamic Settings
C18	1500 pF
R7	910 Ω
C20	33 nF
R8	1.8 kΩ
C22	560 pF
R10	20 kΩ
C23	39 pF
CSCALE	8000 μΑ
Bleed Current	0 μΑ
ABDLY	0.9 nS

If a smaller frequency step size is desired, the ADRF6612 can be used in fractional mode. The 16-bit FRAC\_DIV and MOD\_DIV values available in the ADRF6612 mean that small step sizes can be achieved with high PFD frequencies. PFD spurs may be higher in amplitude, but are spaced further apart. Fractional spurs may be present as well.

# Table 18. Fractional Mode Loop Filter Components and PLL Dynamic Settings

Dynamic Settings	
Loop Filter Components	PLL Dynamic Settings
C18	1000 pF
R7	700 Ω
C20	33 nF
R8	1.8 kΩ
C22	560 pF
R10	20 kΩ
C23	39 pF
CSCALE	500 μΑ
Bleed Current	93.75 μA
ABDLY	0 nS

#### VCOs and Dividers

The ADRF6612 has four internal VCOs. Considering the range of these VCOs, the fixed 2× prescaler after the VCO, and the LO\_DIV (1, 2, 4, 8, 16, and 32) range, the total LO range allows RF generation of 200 MHz to 2700 MHz.

#### Table 19. VCO Range

VCO_SEL (Register 0x22, Bits[2:0]) <sup>1</sup>	Frequency Range (GHz) <sup>1</sup>
000	VCO_0 = 4.6 to 5.7
001	VCO_1 =4.02 to 4.6
010	VCO_2 = 3.5 to 4.02
011	VCO_3 =2.85 to 3.5

<sup>1</sup>For VCO\_0, VCO\_1, VCO\_2, and VCO\_3, set VTUNE\_DAC\_SLOPE (Register 0x49, Bits[13:9]) = 11 (decimal), VTUNE\_DAC\_OFFSET (Register 0x49, Bits[8:0]) = 184 (decimal), VCO\_LDO\_R2 (Register 0x22, Bits[11:8]) = 0 (decimal), and VCO\_LDO\_R4 (Register 0x22, Bits[15:12]) = 5 (decimal).

The N-divider divides down the differential VCO signal to the PFD frequency. The N-divider can be configured for fractional mode or integer mode by addressing the DIV\_MODE bit (Register 0x02, Bit 15). The default configuration is set for fractional mode.

### **Data Sheet**

The following equations can be used to determine the N value and the PLL frequency:

$$f_{PFD} = \frac{f_{VCO}}{2 \times N}$$
$$N = INT + \frac{FRAC}{MOD}$$
$$f_{LO} = \frac{f_{PFD} \times 2 \times N}{LO \ DIVIDER}$$

where:

 $f_{PFD}$  is the phase frequency detector frequency.

 $f_{VCO}$  is the voltage controlled oscillator frequency.

 ${\it N}$  is the fractional divide ratio.

*INT* is the integer divide ratio programmed in Register 0x02. *FRAC* is the fractional divide ratio programmed in Register 0x03. *MOD* is the modulus divide ratio programmed in Register 0x04.  $f_{LO}$  is the LO frequency going to the mixer core when the loop is locked.

*LO\_DIVIDER* is the final divider block that divides the VCO frequency down by 1, 2, 4, or 8 before it reaches the mixer (see Table 20). This control is located in the LO\_DIV bits (Register 0x22, Bits[5:3]).

#### Table 20. LO Divider

LO_DIV (Register 0x22, Bits[5:3])	LO_DIVIDER
00	1
01	2
10	4
11	8

The lock detect signal is available as one of the selectable outputs through the MUXOUT pin; a logic high indicates that the loop is locked. The MUXOUT pin is controlled by the REF\_MUX\_SEL bits (Register 0x21, Bits[14:13]); the PLL lock detect signal is the default configuration.

To ensure that the PLL locks to the desired frequency, follow the proper write sequence of the PLL registers. The PLL registers must be configured accordingly to achieve the desired frequency, and the last writes must be to Register 0x02 (INT\_DIV in Table 25),

Register 0x03 (FRAC\_DIV in Table 25), or Register 0x04 (MOD\_DIV in Table 25). When one of these registers is programmed, an internal VCO calibration is initiated, which is the last step in locking the PLL.

The time it takes to lock the PLL after the last register is written can be broken down into two parts: VCO band calibration and loop settling.

After the last register is written, the PLL automatically performs a VCO band calibration to choose the correct VCO band. This calibration takes approximately 5120 PFD cycles. For a 40 MHz fPFD, this corresponds to 128 µs. After calibration is complete, the feedback action of the PLL causes the VCO to eventually lock to the correct frequency. The speed with which this locking occurs depends on the nonlinear cycle-slipping behavior, as well as the small-signal settling of the loop. For an accurate estimation of the lock time, download the ADIsimPLL<sup>™</sup> tool, which correctly captures these effects. In general, higher bandwidth loops tend to lock faster than lower bandwidth loops.

#### **Additional LO Controls**

To access the LO signal going to the mixer core through the LOOUT+ and LOOUT- pins (Pin 13 and Pin 14), enable the LO\_DRV\_EN bit in Register 0x01, Bit 7. This setting offers direct monitoring of the LO signal to the mixer for debug purposes; or the LO signal can be used to daisy-chain many devices synchronously. One ADRF6612 can serve as the master where the LO signal is sourced, and the subsequent slave devices share the same LO signal from the master. This flexibility substantially eases the LO requirements of a system with multiple LOs.

The LO output drive level is controlled by the LO\_DRV\_LVL bits (Register 0x22, Bits[7:6]). Table 21 shows the available drive levels.

Table 21. LO Drive Levels

LO_DRV_LVL (Register 0x22, Bits[7:6])	Amplitude (dBm)
00	-4
01	0.5
10	3
11	4.5



Figure 94. Simplified Schematic

### **APPLICATIONS INFORMATION**

The ADRF6612 mixer is designed to downconvert radio frequencies (RF) primarily between 700 MHz and 2800 MHz to lower intermediate frequencies (IF) between 30 MHz and 450 MHz. Figure 95 depicts the basic connections of the mixer. It is recommended to ac couple the RF and LO input ports to prevent nonzero dc voltages from damaging the RF balun or LO input circuit. A RFIN capacitor value of 22 pF is recommended.



# **BASIC CONNECTIONS PIN DESCRIPTION**

#### Table 22. Basic Connections

Pin No.	Mnemonic	Description	Basic Connection
5 V Power			Decouple to GND with a 10 $\mu\text{F}$ , a 0.1 $\mu\text{F}$ , and a 10 $\text{pF}$
			capacitor as close to the pin as possible.
7	VCC1	5 V VCO supply	
16	VCC2	5 V supply for SPI port	
20, 41	VCC3, VCC11	5 V biases for IF Channel 2 and IF Channel 1	
27, 28, 29, 32, 33,	VCC4, VCC5, VCC6,	5 V supplies for mixer LO amplifier	
34	VCC8, VCC9, VCC10		
31	VCC7	5 V supply for mixer LO divider chain	
46	VCC12	5 V supply for internal PLL	
Internal LDO Nodes			Decouple to GND with a 10 $\mu$ F and a 100 pF capacitor, as close to the pin as possible.
8,9	DECL1, DECL2	VCO LDO outputs	
10.11.12	DECL3, DECL4, DECL5	External decoupling for VCO circuitry	
15	LD01	External decoupling for internal 2.5 V SPI	
		LDO	
30	LDO2	External decoupling for internal 3.3 V	
		PLL/divider LDO	
44	LDO3	External decoupling for internal 2.5 V PLL LDO	
45	LDO4	External decoupling for internal 3.3 V PLL	
		LDO	
GND			Connect directly to the PCB ground through a low impedance connection.
1	GND	External loop filter ground	
3, 6	GND	Common ground for external loop filter	
24, 37	GND	If stage, Channel 2 and Channel 1 ground	
48	GND	External charge pump ground	
SPI			
17	SDIO	SPI port data input/output	
18	SCLK	SPI port clock	
19	CS	SPI port chip select	
RF, Mixer, IF Path			
4, 5	EXTVCOIN+, EXTVCOIN–	External VCO or LO inputs	DC block with 100 pF capacitors.
13, 14	LOOUT+, LOOUT-	Differential LO outputs	DC block with 100 pF capacitors.
22, 23	IFOUT2+, IFOUT2-	Channel 2 differential IF outputs	Bias to 5 V supply with 330 nH inductors and dc block with 150 pE capacitors
25	RFBCT2	Internal mixer bias control for Channel 2 RF	Decouple to GND with a 10 pF and a 10 nF capacitor,
26	DEINIO	Channel 2 single anded PE input	DC block with a 22 pE capacitor
20 36	REBCT1	Internal mixer bias control for Channel 1 BE	Decouple to GND with a 10 pE and a 10 pE capacitor
50	RIDETT	input	as close to the pin as possible.
35	RFIN1	Channel 1 single-ended RF input	DC block with a 22 pF capacitor.
38, 39	IFOUT1-, IFOUT1+	Channel 1 differential IF outputs	Bias to 5 V supply with 330 nH inductors and dc block with 150 pF capacitors.
PLL/VCO			
2	VCOVTUNE	Control voltage for internal VCO	Output from external loop filter.
43	REFIN	External reference for internal PLL	
47	CPOUT	Charge pump output	Input to external loop filter.
Other			
42	MUXOUT	Output for various internal analog signals, including PLL lock detect and VPTAT	Can be read directly from the pin; the user must be careful of loading effects, not a low impedance output.
21,40	DNC	Do not connect	

### MIXER OPTIMIZATION rf input balun insertion loss optimization

At lower input frequencies, more capacitance is needed. This increase is achieved by programming higher codes into BAL\_COUT. At high frequencies, less capacitance is required; therefore, lower BAL\_COUT codes are appropriate.

As shown in Figure 96 and Figure 97, this tuning range can be further optimized by adding capacitance across the RF input in conjunction with tuning BAL\_COUT. This can help to increase the low frequency range of the device significantly.



Figure 96. Return Loss; Optimum COUT vs. Tuning Capacitor on RFIN Using a High Side LO



Figure 97. Return Loss; Optimum COUT vs. Tuning Capacitor on RFIN Using a Low Side LO

#### **IIP3 OPTIMIZATION**

In applications in which performance is critical, the ADRF6612 offers IIP3 optimization. The IF amplifier bias current can be reduced to trade performance vs. power consumption. This saves on the overall power at the expense of degraded performance.

Figure 98 to Figure 101 show the IIP3 sweeps for all combinations of IFA main bias and linearity bias. The IIP3 vs. IFA main bias and linearity bias figures show both a surface and a contour plot in one figure. The contour plot is located directly underneath the surface plot. The best approach for reading the figure is to localize the peaks on the surface plot, which indicate maximum IIP3, and to follow the same color pattern to the contour plot to determine the optimized IFA main bias and linearity bias settings.



Figure 98. IIP3 vs. Main (IFA\_MAIN) and Linearity Bias (IFA\_LIN) Level at IF Frequency = 50 MHz



Figure 99. IIP3 vs. Main (IFA\_MAIN) and Linearity Bias (IFA\_LIN) Level at IF Frequency = 100 MHz



Figure 100. IIP3 vs. Main (IFA\_MAIN) and Linearity Bias (IFA\_LIN) Level at IF Frequency = 150 MHz



Figure 101. IIP3 vs. Main (IFA\_MAIN) and Linearity Bias (IFA\_LIN) Level at IF Frequency = 200 MHz

#### **VGS PROGRAMMING**

The ADRF6612 allows programmability for internal gate-to-source voltages for optimizing mixer performance over the desired frequency bands. The ADRF6612 default VGS setting is 0. Both channels of the ADRF6612 are programmed together using the same VGS setting. Power conversion gain, input IP3 NF, and input P1dB can be optimized, as shown in Figure 40, Figure 41, Figure 43, and Figure 44.

#### LOW-PASS FILTER PROGRAMMING

The ADRF6612 allows programmability for the low-pass filter terminating the mixer output. This filter helps to block sum term mixing products at the expense of some noise figure and gain and can significantly increase input IP3. The ADRF6612 default LPF setting is 0. Both channels of the ADRF6612 are programmed together using the same LPF settings. Power conversion gain, input IP3, NF, and input P1dB can be optimized, as shown in Figure 42, Figure 45, Figure 46, and Figure 49.

RF Frequency (MHz)	LO Frequency (MHz)	IFA_MAINBIAS	IFA_LINBIAS	BAL_COUT	LPF	VGS
700	497	5	11	14	4	0
800	597	5	11	14	4	0
900	697	5	11	10	4	0
1000	797	5	11	10	4	0
1100	897	5	15	10	4	0
1200	997	5	15	10	4	0
1300	1097	5	15	10	4	0
1400	1197	5	15	6	4	0
1500	1297	5	15	6	4	0
1600	1397	5	15	4	4	0
1700	1497	5	15	4	4	0
1800	1597	5	15	4	4	0
1900	1697	5	15	4	4	0
2000	1797	5	15	4	4	0
2100	1897	5	15	4	4	0
2200	1997	5	15	4	4	0
2300	2097	5	15	2	4	0
2400	2197	5	15	2	4	0
2500	2297	5	15	2	4	0
2600	2397	5	15	2	4	0
2700	2497	5	15	2	4	0
2800	2597	5	15	2	4	0
2900	2697	5	15	0	4	0
3000	2797	5	15	0	4	0

Table 23. Recommended O	ptimum Setting	s for High	Performance N	(in Decimal)

 Table 24. Recommended Optimum Settings for High Efficiency Mode (in Decimal)

RF Frequency (MHz)	LO Frequency (MHz)	IFA_MAINBIAS	IFA_LINBIAS	BAL_COUT	LPF	VGS
700	497	5	15	14	4	0
800	597	5	15	14	4	0
900	697	5	15	10	4	0
1000	797	5	15	10	4	0
1100	897	5	15	10	4	0
1200	997	5	15	10	4	0
1300	1097	5	15	10	4	0
1400	1197	7	15	6	4	0
1500	1297	7	15	6	4	0
1600	1397	7	15	4	4	0
1700	1497	7	15	4	4	0
1800	1597	7	15	4	4	0
1900	1697	7	15	4	4	0
2000	1797	7	15	4	4	0
2100	1897	7	15	4	4	0
2200	1997	7	15	4	4	0
2300	2097	13	15	2	4	0
2400	2197	13	15	2	4	0
2500	2297	13	15	2	4	0
2600	2397	13	15	2	4	0
2700	2497	13	15	2	4	0
2800	2597	13	15	2	4	0
2900	2697	13	15	0	4	0
3000	2797	13	15	0	4	0

# **REGISTER SUMMARY**

#### Table 25. Register Summary

0x00         SOFT_RESET         15.81         SOFT_RESET[15.8]         0x00           0x01         ENABLES         [15.8]         LO_DEN         LO2_ENP         BALUN_EN         LO1_PATH_EN         0x00           0x01         ENABLES         [15.8]         LO_DEN         LO2_ENP         BALUN_EN         LO1_PATH_EN         0x00           0x02         INT_DIV         [15.8]         LO_DRV_EN         VCOBUF_LOD_EN         REF_BUF_EN         VCO_EN         DIV_EN         CP_EN         VCO_LDO_EN         LOD_3P3_EN         0x00           0x02         INT_DIV         [15.8]         DIV_MODE         INT_DIV[7:0]         0x00         0x00         INT_DIV[7:0]         0x00         0x00         0x00         INT_DIV[7:0]         0x00         0x00         IFAA_DIV[7:0]         0x00         0x00         IFA_MAINSLOPE         IFA_MAINSLOPE         IFA_MAINSLOPE         0x00         0x00         0x00         0x00         0x00         0x00         0x00         0x00         0x00	t RW	Reset
Image: mark mark mark mark mark mark mark mark	00 R	0x000
Gx01         ENABLES         [158]         LO_LOD_EN         LO2_ENP         BALUN_EN         LO1_ENP         DV/2P5_EN         PWRUPRX         LO_PATH_EN         Ox00           0x02         INT_DIV         [158]         LO_DRV_EN         VCO_LOD_EN         REF_BUF_EN         VCO_EN         DV/EN         CP_EN         VCO_LOD_EN         LDO_3P3_EN         Ox00           0x02         INT_DIV         [158]         DV_MODE         INT_DIV[7:0]         INT_DIV[7:0]         Ox00           0x03         FRAC_DIV         [158]         ISA         MAD_DIV[7:0]         Ox00         Ox00           0x04         MOD_DIV         [158]         FALUN_HIEFPP         IFA_LINSLOPE         IFA_MAINSLOPE         IFA_MAINBIAS_2         Ox00           0x04         MOD_DIV         [158]         IFA_LINBIAS[1:0]         IFA_LINSLOPE         IFA_MAINBIAS_EN         Ox00           0x04         FBAS         [158]         IFA_LINBIAS[1:0]         IFA_LINSLOPE         IFA_MAINBIAS_EN         Ox00           0x01         IFA_LINBIAS_EN         IFA_LINBIAS_EN         IFA_MAINBIAS_EN         IFA_MAINBIAS_EN         Ox00           0x02         OP_CTRL         [158]         UNUSED         IFA_LINBIAS_EN         Ox00           0x02 <td< td=""><td></td><td>1</td></td<>		1
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	00 RW	0x000
6x02       INT_DIV       158]       DV_MODE       INT_DIV[148]       0x00         6x03       FRAC_DIV       158]		
$ \begin{array}{ c c c c c c } \hline  T,0  &  T,D V[7:0] & $	58 RW	0x005
6x03       FRAC_DIV       [158]       FRAC_DIV[158]       0x02         0x04       MOD_DIV       [158]       FRAC_DIV[70]       0x04         0x04       MOD_DIV       [158]       FA_LINBIAS[31:0]       FRAC_DIV[70]       0x02         0x10       IF_BIAS       [158]       IFA_LINBIAS[1:0]       IFA_LINBIAS_EN       IFA_MAINBLOPE       IFA_MAINBLAS[22]       0x02         0x20       CP_CTRL       [158]       UNUSED       CSCALE       0x00         0x21       PFD_CTRL1       [158]       UNUSED       REF_MUX_SEL       PFD_POLARITY       REFSEL[7:0]       0x02         0x21       PFD_CTRL1       [158]       UNUSED       REF_MUX_SEL       PFD_POLARITY       REFSEL[7:0]       0x02         0x21       PFD_CTRL1       [158]       UNUSED       REF_MUX_SEL       PFD_POLARITY       REFSEL[7:0]       0x02         0x22       VCO_CTRL1       [158]       UNUSED       VCO_LDO_R2       0x02		
$ \begin{array}{ c c c c c c } \hline FRAC_DIV[7:3] & FRAC_DIV[7:3] & OCC \\ \hline FRAC_DIV[7:5] & OCC & OCC \\ \hline FRAC_DIV[7:5] & OCC & $	50 RW	0x025
0x04         MOD_DIV         [15:8]         MOD_DIV[7:0]         0x06           0x10         [F.8IAS         [15:8]         [FA_LIN_HIEFFP         [FA_LINSLOPE         [FA_MAINSLOPE         [FA_LINBIAS[3:2]         0x06           0x20         [F_BIAS         [15:8]         UNUSED         IFA_LINBIAS_EN         IFA_MAINSIAS         [FA_MAINSIAS_EN         0x06           0x20         [CP_CTRL         [15:8]         UNUSED         CSCALE         0x00		
$ \begin{array}{ c c c c c c } \hline  c c c c c c c c c c c c c c c c c c $	00 RW	0x060
0x10         IF_BIAS         Ifs.8]         IFA_LIN_HIEFFP         IFA_LINBIAS[1:0]         IFA_LINBIAS[2:0]         IFA_LINBIAS[1:0]         IFA_LINBIAS[1:0]         IFA_LINBIAS[1:0]         IFA_LINBIAS[2:0]         0x00           0x20         CP_CTRL         [15.8]         UNUSED         CSCALE         IFA_MAINBIAS         IFA_MAINBIAS_EN         0x00           0x10         PFD_CTRL1         [15.8]         UNUSED         CSCALE         0x00         0x00           0x21         PFD_CTRL1         [15.8]         UNUSED         REF_MUX_SEL         PFD_POLARITY         REFSEL[11:8]         0x00           0x21         PFD_CTRL1         [15.8]         UNUSED         REF_MUX_SEL         PFD_POLARITY         REFSEL[11:8]         0x00           0x22         VC0_CTRL1         [15.8]         UNUSED         REFSEL[7:0]         0x00         0x00           0x30         BALUN_CTRL         [15.8]         UNUSED         VC0_LDO_R2         0x00         0x00           0x40         PFD_CTRL2         [15.8]         UNUSED         VGS         LPF         0x00           0x42         DTH_CTRL2         [15.8]         UNUSED[3:0]         UNUSED[11:4]         0x00         0x00           0x43         DTH_CTRL2         [15.8]		
$ \begin{array}{ c c c c c c } \hline  FA\_LINBIAS[1:0] &  FA\_LINBIAS\_N &  FA\_AMAINBIAS &  FA\_AMAINBIAS\_N &  FA\_AMAINBIAS\_ &  FA\_AMAINBIAS\_ &  FA\_AMAINBIAS\_ &  FA\_AMAINBIAS\_ &  FA\_AMAINSAN\_ &  FA$	B5 RW	0x02E
0x20         CP_CTRL         [15.8]         UNUSED         CSCALE         0x00           7/0         BLEED_POLARITY         BLEED         BLEED         0x00		
0x21   0x21   0x2E	26 RW	0x002
0x21         PFD_CTRL1         [15.8]         UNUSED         REF_MUX_SEL         PFD_POLARITY         REFSEL[11:8]         0x00           7.0]		
$ \begin{array}{ c c c c } \hline REFSEL[7:0] & & & & & & & & & & & & & & & & & & &$	03 RW	_0x000
$ \begin{array}{ c c c c c } \hline \mbox{VCO\_LDO\_R4} & \mbox{VCO\_LDO\_R2} & \mbox{VCD\_LDD\_R2} & \\mbox{VCD\_LDD\_R2} & \\\mbox{VCD\_LDD\_R2} & \\V$		<u> </u>
$ \begin{array}{ c c c c c } \hline  c c c c c c c c c c c c c c c c c c $	0A RW	0x000
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$		<u> </u>
$ \begin{array}{ c c c c c c } \hline \begin{tabular}{ c c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	00 RW	0x000
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$		<u> </u>
$ \begin{array}{ c c c c c c c } \hline \begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	10 RW	0x001
0x42         DITH_CTRL1         [15:8]         UNUSED[1:4]         0x00           7/0]         UNUSED[3:0]         DITH_EN         DITH_MAG         DITH_VAL_H           0x43         DITH_CTRL2         [15:8]         DITH_VAL_L[15:8]         0x00           7/0]         DITH_VAL_L[15:8]         0x00         DITH_VAL_L[7:0]         0x00           0x44         SYNTH_FCNTN_CTRL         [15:8]         UNUSED[1:0]         UNUSED[9:2]         0x00           7/0]         UNUSED[1:0]         DIV_SDM_DIS         VCOCNT_CG_DIS         BANDCAL_CG_DIS         SDM_DIVD_CLR         BANDCAL_DIVD_CLR		<u> </u>
Image: Constraint of the system of	0E RW	0x000
0x43         DITH_CTRL2         [15:8]         DITH_VAL_[15:8]         0x00           [7:0]         [7:0]         DITH_VAL_[17:0]         0x00		
Image: Constraint of the synth of the synthof the synth of the synth of the synth of the synth of t	01 RW	0x000
UNUSED[9:2]     UNUSED[9:2]     0x00       [7:0]     UNUSED[1:0]     DIV_SDM_DIS     VCOCNT_CG_DIS     BANDCAL_CG_DIS     SDM_DIVD_CLR     BANDCAL_DIVD_CLR	0.0	-
[/30] UNUSED[1:0] DIV_SDM_DIS VCOCNT_CG_DIS BANDCAL_CG_DIS SDM_CG_DIS SDM_DIVD_CLR BANDCAL_DIVD_CLR	00 RW	0x000
	20 014	0.007
	20 RW	0x002
		0.000
		-00000
		0,000
		- 00000
		0,000
		-
		1 02000
		0~000
		-
	00 R	0x000
0x70 VARIATION2 [158] SF VFR PART [D[11:8] 0x20	01 R	0x200
[7:0] PART ID[7:0]		-
0x7E VARIATION3 [15:8] IS RESET VCO SW CAL VARIANT 0x00	01 R	0x000
[7:0] BE VER FE VER		1
0x7F VARIATION4 [15:8] SIF VER PART ID[11:8] 0x20	01 R	0x200
[7:0] PART_ID[7:0]		1

### **REGISTER DETAILS**

#### Address: 0x00, Reset: 0x0000, Name: SOFT\_RESET



[15:0] SOFT\_RESET (R) SOFT RESET

0: any write to this register will assert soft reset command

#### Table 26. Bit Descriptions for SOFT\_RESET

Bits	Bit Name	Settings	Description	Reset	Access
[15:0]	SOFT_RESET		Soft reset bit	0x0	R
		0	Any write to this register will assert soft reset command	0x0	R

#### Address: 0x01, Reset: 0x0000, Name: ENABLES



Bits	Bit Name	Settings	Description	Reset	Access
15	LO_LDO_EN		Power up LO LDO	0x0	RW
14	LO2_ENP		LO 2 enable		RW
13	BALUN_EN		Input Balun enable	0x0	RW
12	LO1_ENP		LO 1 enable	0x0	RW
11	DIV2P5_EN		Enable dividers 2.5 V LDO	0x0	RW
[10:9]	PWRUPRX		Power up Rx	0x0	RW
		0x0	Power down both mixer channels		
		0x1	Power up mixer Channel 1		
		0x2	Power up mixer Channel 2		
		0x3	Power up both mixer channels		
8	LO_PATH_EN		External LO path enable	0x0	RW
7	LO_DRV_EN		LO driver enable	0x0	RW

#### Table 27. Bit Descriptions for ENABLES

### **Data Sheet**

Bits	Bit Name	Settings	Description	Reset	Access
6	VCOBUF_LDO_EN		VCO buffer LDO enable	0x0	RW
5	REF_BUF_EN		Reference buffer enable	0x0	RW
4	VCO_EN		Power up VCOs	0x0	RW
3	DIV_EN		Power up dividers	0x0	RW
2	CP_EN		Power up charge pump	0x0	RW
1	VCO_LDO_EN		Power up VCO LDO	0x0	RW
0	LDO_3P3_EN		Power up 3.3 V LDO	0x0	RW

#### Address: 0x02, Reset: 0x0058, Name: INT\_DIV



#### Table 28. Bit Descriptions for INT\_DIV

Bits	Bit Name	Settings	Description	Reset	Access
15	DIV_MODE		Set fractional/integer mode	0x0	RW
		0	Fractional		
		1	Integer		
[14:0]	INT_DIV		Set divider INT value	0x58	RW

#### Address: 0x03, Reset: 0x0250, Name: FRAC\_DIV



Set divider FRAC value

#### Table 29. Bit Descriptions for FRAC\_DIV

Bits	Bit Name	Settings	Description	Reset	Access
[15:0]	FRAC_DIV		Set divider FRAC value	0x250	RW

#### Address: 0x04, Reset: 0x0600, Name: MOD\_DIV



#### Table 30. Bit Descriptions for MOD\_DIV

Bits	Bit Name	Settings	Description	Reset	Access
[15:0]	MOD_DIV		Set divider MOD value	0x600	RW

#### Address: 0x10, Reset: 0x02B5, Name: IF\_BIAS



#### Table 31. Bit Descriptions for IF\_BIAS

Bits	Bit Name	Settings	Description	Reset	Access
15	IFA_LIN_HIEFFP		Linearity RDAC: 0 = high performance mode, 1 = high efficiency mode	0x0	RW
14	IFA_MAIN_HIEFFP		Main RDAC: 0 = high performance mode, 1 = high efficiency mode	0x0	RW
[13:12]	IFA_LINSLOPE		Linearity Slope Adj for IF amps (IPMix)	0x0	RW
[11:10]	IFA_MAINSLOPE		Main Slope Adj for IF amps (IPMix)	0x0	RW
[9:6]	IFA_LINBIAS		Linearity Bias Adj for IF amps (IPMix)	0xa	RW
5	IFA_LINBIAS_EN		Enable internal Linearity Bias Adj for IF amps (IPMix)	0x1	RW
[4:1]	IFA_MAINBIAS		Main Bias Adj for IF Amps (IPMix)	0xa	RW
0	IFA_MAINBIAS_EN		Enable internal Main Bias Adj for IF amps (IPMix)	0x1	RW

#### Address: 0x20, Reset: 0x0026, Name: CP\_CTRL



#### Table 32. Bit Descriptions for CP\_CTRL

Bits	Bit Name	Settings	Description	Reset	Access
[15:14]	UNUSED		Unused	0x0	RW
[13:8]	CSCALE		Charge pump current adjust	0x0	RW
7	BLEED_POLARITY		Charge pump bleed current polarity	0x0	RW
[6:0]	BLEED		Charge pump bleed	0x26	RW

#### Address: 0x21, Reset: 0x0003, Name: PFD\_CTRL1



#### Table 33. Bit Descriptions for PFD\_CTRL1

Bits	Bit Name	Settings	Description	Reset	Access
15	UNUSED		Unused	0x0	RW
[14:13]	REF_MUX_SEL		REF output divide ratio/VPTAT/SCAN/LOCK_DET	0x0	RW
		000	LOCK_DET		
		001	VPTAT		
		010	REFCLK		
		011	REFCLK/2		
		100	REFCLKx2		
		101	REFCLK/8		
		110	REFCLK/4		
		111	SCAN		
12	PFD_POLARITY		PFD polarity	0x0	RW
		0	POS		
		1	NEG		
[11:0]	REFSEL		REF input divide ratio	0x3	RW

#### Address: 0x22, Reset: 0x000A, Name: VCO\_CTRL1



#### Table 34. Bit Descriptions for VCO\_CTRL1

Bits	Bit Name	Settings	Description	Reset	Access
[15:12]	VCO_LDO_R4		VCO LDO R4 control setting	0x0	RW
[11:8]	VCO_LDO_R2		VCO LDO R2 control setting	0x0	RW
[7:6]	LO_DRV_LVL		External LO amplitude	0x0	RW
		00	–0.8 dBm/15 mA		
		01	4.6 dBm/28 mA		
		10	7.5 dBm/40 mA		
		11	9.2 dBm/49 mA		
[5:3]	LO_DIV		LO_DIV	0x1	RW
		00	DIV1		
		01	DIV2		
		10	DIV4		
		11	DIV8		
[2:0]	VCO_SEL		Select VCO core/external LO	0x2	RW
		000	VCO_0 = 4.6 GHz to 5.7 GHz		
		001	VCO_1 = 4.02 GHz to 4.6 GHz		
		010	VCO_2 = 3.5 GHz to 4.02 GHz		
		011	VCO_3 = 2.85 GHz to 3.5 GHz		
		100	None		
		101	None		
		110	External LO/VCO		
		111	None		

#### Address: 0x30, Reset: 0x0000, Name: BALUN\_CTRL



#### Table 35. Bit Descriptions for BALUN\_CTRL

Bits	Bit Name	Settings	Description	Reset	Access
[15:14]	UNUSED		Unused	0x0	RW
[13:11]	VGS		Mixer VGS bias	0x0	RW
[10:8]	LPF		Mixer output IF low-pass filter	0x0	RW
[7:4]	BAL_COUT		Set balun C <sub>out</sub> (both channels)	0x0	RW
[3:0]	RESERVED		Reserved, set to 0x0	0x0	RW

#### Address: 0x40, Reset: 0x0010, Name: PFD\_CTRL2



#### Table 36. Bit Descriptions for PFD\_CTRL2

Bits	Bit Name	Settings	Description	Reset	Access
[15:9]	UNUSED		Unused	0x0	RW
[8:5]	ABLDLY		Set antibacklash delay	0x0	RW
		00	0 ns		
		01	0.5 ns		
		10	0.75 ns		
		11	0.9 ns		

Bits	Bit Name	Settings	Description	Reset	Access
[4:2]	CPCTRL		Set charge pump control	0x4	RW
		000	Both ON		
		001	Pump DWN		
		010	Pump UP		
		011	Tristate		
		100	PFD		
		101			
		110			
		111			
[1:0]	CLKEDGE		Set PFD edge sensitivity	0x0	RW
		00	Div and REF DWN edge		
		01	Div DWN edge, REF UP edge		
		10	Div UP edge, REF DWN edge		
		11	Div and REF UP edge		

#### Address: 0x42, Reset: 0x000E, Name: DITH\_CTRL1



#### Table 37. Bit Descriptions for DITH\_CTRL1

Bits	Bit Name	Settings	Description	Reset	Access
[15:4]	UNUSED		Unused register bits	0x0	RW
3	DITH_EN		Set dither enable	0x1	RW
		0	Disable		
		1	Enable		
[2:1]	DITH_MAG		Dither magnitude	0x3	RW
0	DITH_VAL_H		High bit of 17 bit dither value	0x0	RW

#### Address: 0x43, Reset: 0x0001, Name: DITH\_CTRL2



[15:0] DITH\_VAL\_L (RW) \_ Low 16 bits of 17 bit dither value

#### Table 38. Bit Descriptions for DITH\_CTRL2

Bits	Bit Name	Settings	Description	Reset	Access
[15:0]	DITH_VAL_L		Low 16 bits of 17 bit dither value	0x1	RW

#### Address: 0x44, Reset: 0x0000, Name: SYNTH\_FCNTN\_CTRL



#### Table 39. Bit Descriptions for SYNTH\_FCNTN\_CTRL

Bits	Bit Name	Settings	Description	Reset	Access
[15:6]	UNUSED		Unused	0x0	RW
5	DIV_SDM_DIS		Disable SDM divider	0x0	RW
4	VCOCNT_CG_DIS		Disable BIST clock	0x0	RW
3	BANDCAL_CG_DIS		Disable bandcal clock	0x0	RW
2	SDM_CG_DIS		Disable SDM clock	0x0	RW
1	SDM_DIVD_CLR		SDM_DIVD_CLR	0x0	RW
0	BANDCAL_DIVD_CLR		BANDCAL_DIVD_CLR	0x0	RW

#### Address: 0x45, Reset: 0x0020, Name: VCO\_CTRL2



#### Table 40. Bit Descriptions for VCO\_CTRL2

Bits	Bit Name	Settings	Description	Reset	Access
[15:8]	UNUSED		Unused	0x0	RW
7	VCO_BAND_SRC		Set VCO band source	0x0	RW
		0	Automatic		
		1	Manual		
[6:0]	BAND		Set VCO band	0x20	RW

unused

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#### Address: 0x46, Reset: 0x0000, Name: VCO\_CTRL3



#### Table 41. Bit Descriptions for VCO\_CTRL3

Bits	Bit Name	Settings	Description	Reset	Access
[15:8]	UNUSED		Unused	0x0	RW
7	VCO_CNTR_DONE		Read back BIST counter status	0x0	R
[6:0]	VCO_BAND		Read back output of bandcap mux	0x0	R

#### Address: 0x47, Reset: 0x0000, Name: VCO\_CNTR\_CTRL



#### Table 42. Bit Descriptions for VCO\_CNTR\_CTRL

Bits	Bit Name	Settings	Description	Reset	Access
[15:4]	UNUSED		Unused	0x0	RW
[3:2]	VCO_CNTR_REFCNT		BIST counter integration interval	0x0	RW
1	VCO_CNTR_CLR		Clear BIST counter	0x0	RW
0	VCO_CNTR_EN		Enable BIST counter	0x0	RW

#### Address: 0x48, Reset: 0x0000, Name: VCO\_CNTR\_RB



[15:0] VCO\_CNTR\_RB (R) Read back output of BIST counter

#### Table 43. Bit Descriptions for VCO\_CNTR\_RB

Bits	Bit Name	Settings	Description	Reset	Access
[15:0]	VCO_CNTR_RB		Read back output of BIST counter	0x0	R

#### Address: 0x49, Reset: 0x0000, Name: VTUNE\_DAC\_CTRL



#### Table 44. Bit Descriptions for VTUNE\_DAC\_CTRL

Bits	Bit Name	Settings	Description	Reset	Access
[15:14]	UNUSED		Unused	0x0	RW
[13:9]	VTUNE_DAC_SLOPE		Set VTUNE PTAT DAC	0x0	RW
[8:0]	VTUNE_DAC_OFFSET		Set VTUNE ZTAT DAC	0x0	RW

#### Address: 0x4A, Reset: 0x0000, Name: VCO\_BUF\_LDO



#### Table 45. Bit Descriptions for VCO\_BUF\_LDO

Bits	Bit Name	Settings	Description	Reset	Access
[15:8]	UNUSED		Unused	0x0	RW
[7:4]	VCOBUF_LDO_R4		VCOBUF LDO R4 control	0x0	RW
[3:0]	VCOBUF_LDO_R2		VCOBUF LDO R2 control	0x0	RW

#### Address: 0x7C, Reset: 0x0000, Name: VARIATION1



#### Table 46. Bit Descriptions for VARIATION1

Bits	Bit Name	Settings	Description	Reset	Access
15	IS_RESET		IS reset	0x0	R
14	VCO_SW_CAL		VCO switch calibration	0x0	R
[13:8]	VARIANT		Experimental variant	0x0	R
[7:4]	BE_VER		Back end of line revision	0x0	R
[3:0]	FE_VER		Front end of line revision	0x0	R

#### Address: 0x7D, Reset: 0x2001, Name: VARIATION2



#### Table 47. Bit Descriptions for VARIATION2

Bits	Bit Name	Settings	Description	Reset	Access
[15:12]	SIF_VER		Serial interface version	0x2	R
[11:0]	PART_ID		Product ID	0x1	R

#### Address: 0x7E, Reset: 0x0001, Name: VARIATION3



#### Table 48. Bit Descriptions for VARIATION3

Bits	Bit Name	Settings	Description	Reset	Access
15	IS_RESET		IS reset	0x0	R
14	VCO_SW_CAL		VCO switch calibration	0x0	R
[13:8]	VARIANT		Experimental variant	0x0	R
[7:4]	BE_VER		Back end of line revision	0x0	R
[3:0]	FE_VER		Front end of line revision	0x1	R

#### Address: 0x7F, Reset: 0x2001, Name: VARIATION4



#### Table 49. Bit Descriptions for VARIATION4

Bits	Bit Name	Settings	Description	Reset	Access
[15:12]	SIF_VER		Serial interface version	0x2	R
[11:0]	PART_ID		Product ID	0x1	R

### **EVALUATION BOARD**

An evaluation board is available for the ADRF6612. The standard evaluation board schematic is presented in Figure 102. The USB interface circuitry schematic is presented in Figure 104. The evaluation board layout is shown in Figure 105 and Figure 106. The evaluation board is fabricated using Rogers\* 3003 material. Table 50 details the configuration for the mixer characterization. The evaluation board software is available on the ADRF6612 product page.



Figure 102. Evaluation Board, Main Circuitry

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**Data Sheet** 



Figure 103. Evaluation Board, Legacy USB Interface



Figure 104. Evaluation Board, ADI SDP-S USB Interface

Components	Description	Default Conditions
C1, C2, C8, C11, C12, C13, C14, C15, C18, C19, C20, C23, C26, C27	Power supply decoupling. Nominal supply decoupling consists of a 0.1 $\mu$ F capacitor to ground in parallel with a 10 pF capacitor to ground positioned as close to the device as possible.	C1, C2, C26, C27 = 0.1 μF (size 0402), C8, C11, C12, C13, C14, C15, C18, C19, C20, C23 = 10 pF (size 0402)
C6, C7, C24, C25	RF input interface. The input channels are ac-coupled through C6 and C24. C7 and C25 provide bypassing for the center tap of the RF input baluns.	C6, C24 = 22 pF (size 0402), C7, C25 = 22 pF (size 0402)
C3, C4, C5, C28, C29, C30, L1, L2, L3, L4, R20, R21, R22, R23, T1, T2	IF output interface. The open-collector IF output interfaces are biased through pull-up choke inductors L1, L2, L3, and L4. T1 and T2 are 4:1 impedance transformers used to provide single-ended IF output interfaces, with C5 and C30 providing center-tap bypassing. Remove R21 and R22 for balanced output operation.	C3, C4, C5, C28, C29, C30 = 120 pF (size 0402), L1, L2, L3, L4 = 470 nH (size 0603), R20, R23 = open, R21, R22 = 0 $\Omega$ (size 0402), T1, T2 = TC4-1W+ (Mini-Circuits <sup>®</sup> )
C17	LO interface. C17 provides ac coupling for the LOIP local oscillator input.	C17 = 22 pF (size 0402)
R1, R2	Bias control. R1and R2 set the bias point for the internal IF amplifier.	R1, R2 = 910 $\Omega$ (size 0402)

### Table 50. Evaluation Board Configuration



Figure 105. Evaluation Board, Top Layer

12199-205



Figure 106. Evaluation Board, Bottom Layer

### **OUTLINE DIMENSIONS**



#### **ORDERING GUIDE**

Model <sup>1</sup>	Temperature Range	Package Description	Package Option
ADRF6612ACPZ-R7	-40°C to +85°C	48-Lead Lead Frame Chip Scale Package [LFCSP]	CP-48-13
ADRF6612-EVALZ		Evaluation Board	

<sup>1</sup> Z = RoHS Compliant Part.

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